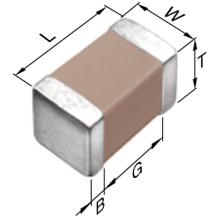


C3225JB1C685M200AA



TDK item description C3225JB1C685MT****

Applications	Commercial Grade
Feature	General General (Up to 50V)
Series	C3225 [EIA 1210]
Status	Production (Not Recommended for New Design)



Dimensions in mm

Size	
Length(L)	3.20mm ±0.40mm
Width(W)	2.50mm ±0.30mm
Thickness(T)	2.00mm ±0.20mm
Terminal Width(B)	0.20mm Min.
Terminal Spacing(G)	
Recommended Land Pattern (PA)	2.00mm to 2.40mm
Recommended Land Pattern (PB)	1.00mm to 1.20mm
Recommended Land Pattern (PC)	1.90mm to 2.50mm

Electrical Characteristics	
Capacitance	6.8μF ±20%
Rated Voltage	16VDC
Temperature Characteristic	JB(±10%)
Dissipation Factor (Max.)	2.5%
Insulation Resistance (Min.)	14MΩ

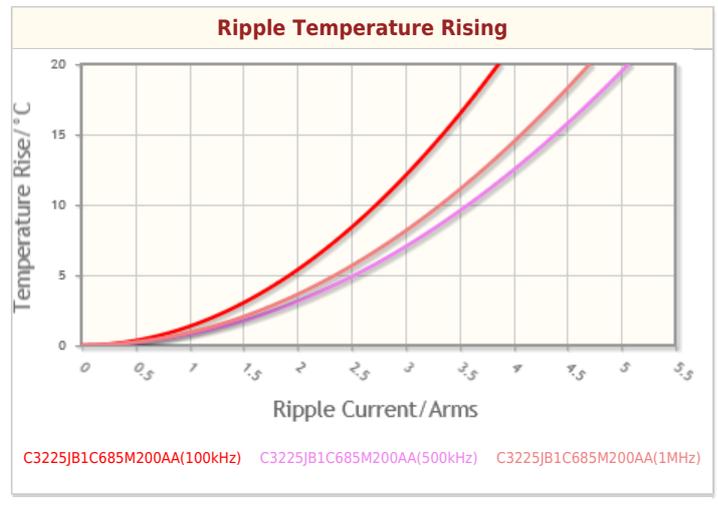
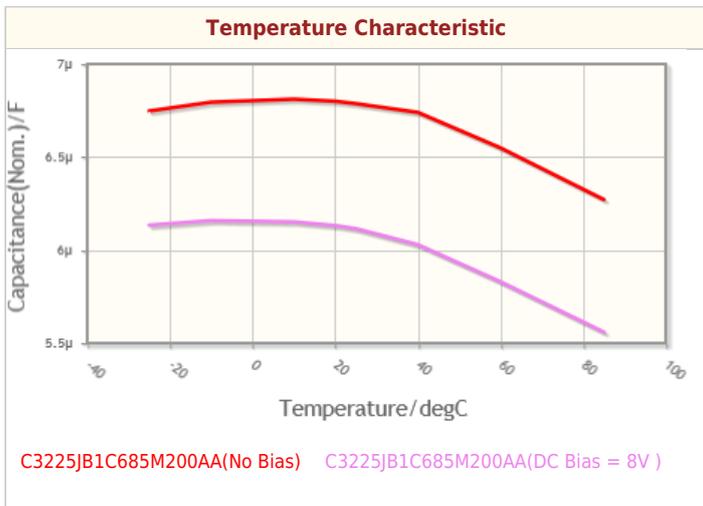
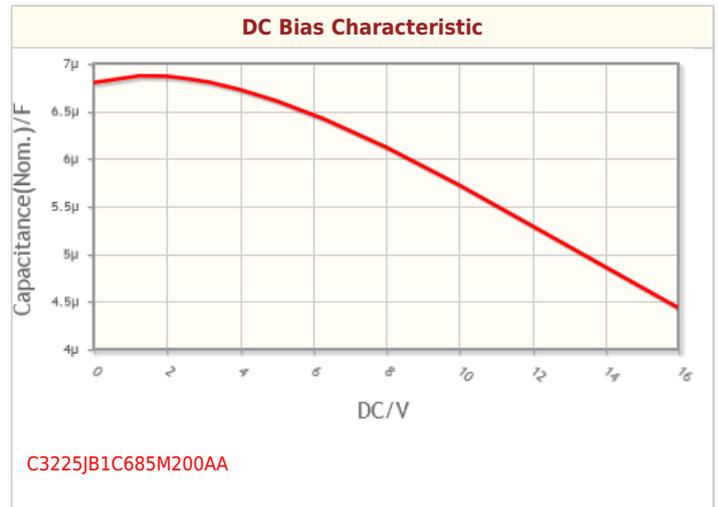
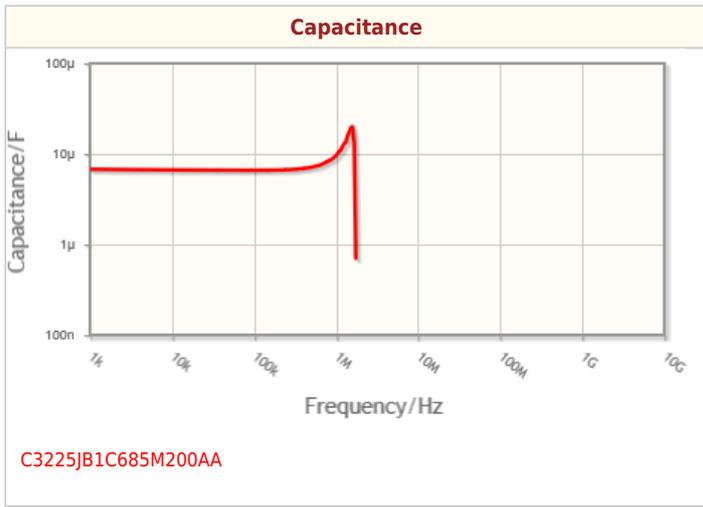
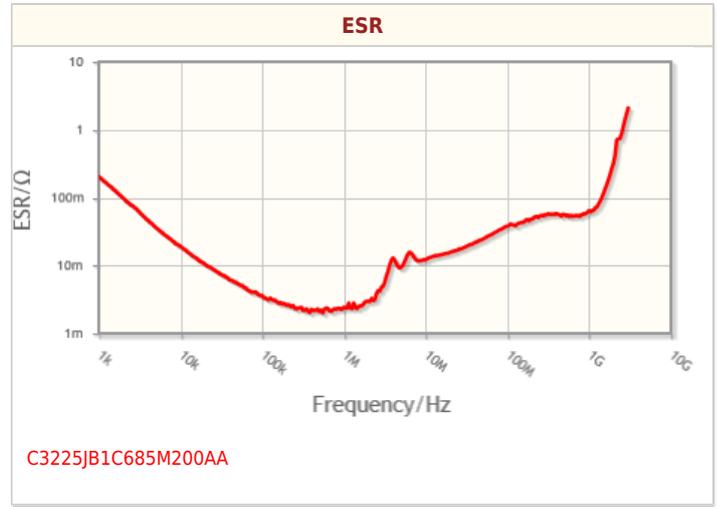
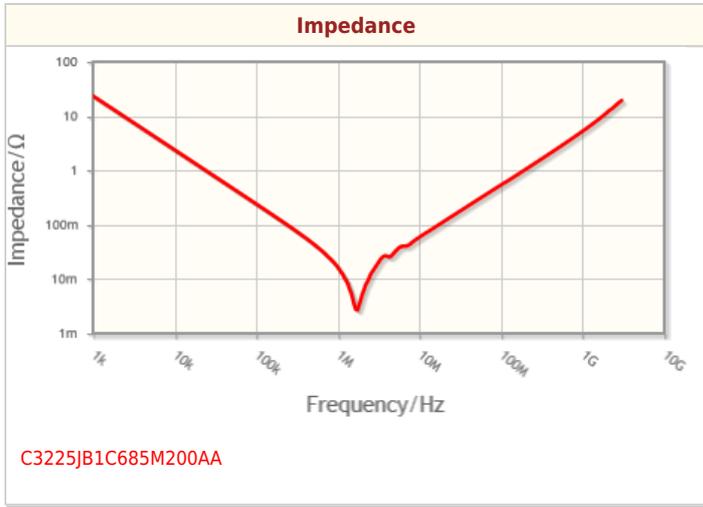
Other	
Soldering Method	Reflow
AEC-Q200	No
Packing	Blister (Plastic)Taping [180mm Reel]
Package Quantity	1000pcs

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! This PDF document was created based on the data listed on the TDK Corporation website.
! All specifications are subject to change without notice.

C3225JB1C685M200AA



Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

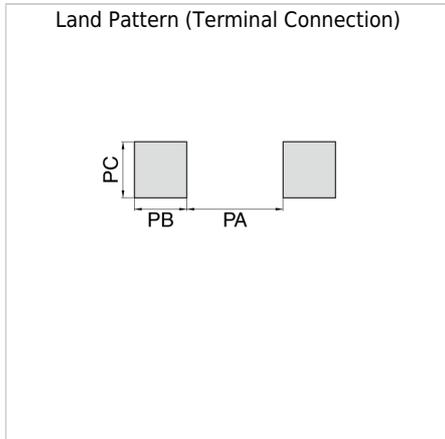


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C3225JB1C685M200AA



Associated Images



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